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SOT-23 Formed SMD Package

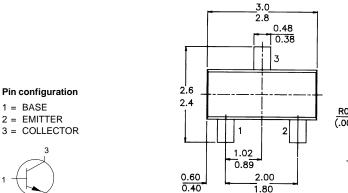
CMBT4401

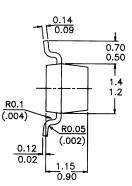
SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor

Marking CMBT4401 = 2X

PACKAGE OUTLINE DETAILS ALL DIMENSIONS IN mm





1 = BASE2 = EMITTER



ABSOLUTE MAXIMUM RATINGS

Collector-emitter voltage	V_{CEO}	max.	40 V
Collector current (DC)	I_C	max.	600 mA
DC current gain			400
$I_C = 150 \text{ mA}; V_{CE} = 1 \text{ V}$	$h_{\!F\!E}$	min. max.	100 300
Total power dissipation up to $T_{amb} = 25$ °C	P_{tot}	max.	250 mW

RATINGS (at $T_A = 25^{\circ}C$ unless otherwise specified)

Limiting values Collector-emitter voltage 40 V V_{CEO} max. Collector-base voltage 60 V V_{CBO} max. Emitter-base voltage V_{EBO} max. 6 V 600 mA Collector current (DC) max. I_C Total power dissipation up to $T_{amb} = 25^{\circ}C$ 250 mW P_{tot} max Storage temperature range T_{stg} −55 to +150 ° C 150 ° C Junction temperature max.

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From junction to ambient $R_{th\ j-a}=500\ \text{K/W}$ CHARACTERISTICS $T_{amb}=25\ ^{\circ}C$ unless otherwise specified Collector-emitter breakdown voltage $I_{C}=1.0\ \text{mA};\ I_{B}=0$ $V_{(BR)CEO}>40\ \text{V}$ Collector-base breakdown voltage $I_{C}=100\ \mu\text{A};\ I_{E}=0$ $V_{(BR)CBO}>60\ \text{V}$ Emitter-base breakdown voltage $I_{E}=100\ \mu\text{A};\ I_{C}=0$ $V_{(BR)EBO}>60\ \text{V}$ Base cut-off current
$T_{amb} = 25$ °C unless otherwise specified Collector-emitter breakdown voltage $I_C = 1.0$ mA; $I_B = 0$ $V_{(BR)CEO} > 40$ V Collector-base breakdown voltage $I_C = 100$ μ A; $I_E = 0$ $V_{(BR)CBO} > 60$ V Emitter-base breakdown voltage $I_E = 100$ μ A; $I_C = 0$ $V_{(BR)EBO} > 6$ V
Collector-emitter breakdown voltage $I_{C} = 1.0 \text{ mA}; I_{B} = 0 \qquad V_{(BR)CEO} > 40 \text{ V}$ Collector-base breakdown voltage $I_{C} = 100 \text{ µA}; I_{E} = 0 \qquad V_{(BR)CBO} > 60 \text{ V}$ Emitter-base breakdown voltage $I_{E} = 100 \text{ µA}; I_{C} = 0 \qquad V_{(BR)EBO} > 6 \text{ V}$
$I_C = 1.0$ mA; $I_B = 0$ $V_{(BR)CEO} > 40 \ V$ Collector-base breakdown voltage $I_C = 100 \ \mu A$; $I_E = 0$ $V_{(BR)CBO} > 60 \ V$ Emitter-base breakdown voltage $I_E = 100 \ \mu A$; $I_C = 0$ $V_{(BR)EBO} > 6 \ V$
Collector-base breakdown voltage $I_{C} = 100 \ \mu A; I_{E} = 0 \qquad V(BR)CBO > 60 \ V$ Emitter-base breakdown voltage $I_{E} = 100 \ \mu A; I_{C} = 0 \qquad V(BR)EBO > 6 \ V$
Collector-base breakdown voltage $I_C = 100 \ \mu A; I_E = 0$ $V_{(BR)CBO} > 60 \ V$ Emitter-base breakdown voltage $I_E = 100 \ \mu A; I_C = 0$ $V_{(BR)EBO} > 6 \ V$
Emitter-base breakdown voltage $I_E = 100 \ \mu A; I_C = 0$ $V_{(BR)EBO} > 6 \ V$
$I_E = 100 \ \mu A; I_C = 0$ $V_{(BR)EBO} > 6 \ V$
Base cut-off current
$V_{CE} = 35 \ V; \ V_{EB} = 0.4 \ V$ $I_{BEX} < 0.1 \ \mu A$
Collector cut-off current
$V_{CE} = 35 \ V; \ V_{EB} = 0.4 \ V$
D.C. current gain
$I_C = 0.1 \text{ mA}; V_{CE} = 1 \text{ V}$
$I_C = 1.0 \text{ mA}; V_{CE} = 1 \text{ V}$ $h_{FE} > 40$
$I_C = 10 \text{ mA}; V_{CE} = 1 \text{ V}$ $h_{FE} > 80$
$I_C = 150 \text{ mA}; V_{CE} = 1 \text{ V}$ hfe 100 to 300
$I_C = 500 \text{ mA}; V_{CE} = 2 \text{ V}$ $h_{FE} > 40$
Saturation voltage
$I_C = 150 \text{ mA}; I_B = 15 \text{ mA}$ $V_{CEsat} < 0.4 \text{ V}$
V_{BEsat} 0.75 to 0.95 V
$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$ $V_{CEsat} < 0.75 \text{ V}$
VBEsat < 1.2 V
Transition frequency
$f = 100 \text{ MHz}; I_C = 20 \text{ mA}; V_{CE} = 10 \text{ V}$ $f_T > 250 \text{ MHz}$
Collector-base capacitance
$I_E = 0; V_{CB} = 5 V; f = 100 kHz$ $C_{cb} < 8 pF$
Emitter-base capacitance
$I_{C} = 0; V_{BE} = 0.5 V; f = 100 kHz$ $C_{eb} < 30 pF$
Input impedance; $f = 1 \text{ kHz}$;
$I_C = 1 \text{ mA}; V_{CE} = 10 \text{ V}$ h_{ie} $min.$ $1 \text{ k}\Omega$
$max.$ 8 $k\Omega$
Voltage feed-back ratio min. 0.1×10^{-4}
$I_C = 1 \text{ mA}; V_{CE} = 10 \text{ V}; f = 1 \text{ kHz}$ h_{re} $max. 30 \times 10^{-4}$
Small-signal curent gain; $f = 1$ kHz;
$I_C = 1 \text{ mA}$; $V_{CE} = 10 \text{ V}$ h_{fe} min. 40
max. 500

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Output admittance; $f = 1 \text{ kHz}$;		min.	1	μS
$I_C = 1 \text{ mA}; V_{CE} = 10 \text{ V}$	h_{oe}			•
		max.	30	μS
Switching times (resistive load)				
Turn-on time				
$I_C = 150 \text{ mA}; I_{B1} = 15 \text{ mA};$				
$V_{CC} = 30 \ V; \ V_{EB} = 2 \ V$				
delay time	t_d	max.	15	ns
rise time	$t_{arGamma}$	max.	20 ns	
Turn-off time				
$I_C = 150 \text{ mA}; V_{CC} = 30 \text{ V};$				
$I_{B1} = I_{B2} = 15 \text{ mA}$				
storage time	t_{S}	max.	225 ns	
fall time	t_f	max.	30 ns	

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